

HMW30 规格书(Line-up)

基板 CCL: HMW30

1、 Only E-Glass Type CCL: HMW30

Core Thickness		Dk				Df			
mil	mm	1GHz	5GHz	10GHz	15GHz	1GHz	5GHz	10GHz	15GHz
5.0	0.127	3.01	3.01	3.00	2.99	0.0018	0.0019	0.0020	0.0021
10.0	0.254	3.01	3.01	3.00	2.99	0.0018	0.0019	0.0020	0.0021
20.0	0.508	3.01	3.01	3.00	2.99	0.0018	0.0019	0.0020	0.0021
30.0	0.762	3.01	3.01	3.00	2.99	0.0018	0.0019	0.0020	0.0021

Copper foil		Pnl size	
thickness	Type	Warp	Fill
1/2oz	HVLP	48"	54"
1oz	HVLP	36"	48"
2oz	RTF	18"	24"
3oz	RTF		

Remark: 1. The above data is for your reference only.

2. Please contact WAZAM sale and TS team if need more Laminates type.